

Influence of SiO₂ Capping and Annealing on the Luminescence Properties of Larva-Like GaS Nanostructures

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Received June 27, 2012, Accepted August 1, 2012

Larva-like GaS nanostructures synthesized by the thermal evaporation of Ga metals and S powders were coated with SiO₂ by the sputtering technique. Transmission electron microscopy and X-ray diffraction analyses revealed that the cores and shells of the GaS-core/SiO₂-shell larva-like nanostructures were single crystal wurtzite-type hexagonal structured-GaS and amorphous SiO₂, respectively. Photoluminescence (PL) measurements at room temperature showed that the passivation of the larva-like GaS nanostructures was successfully achieved with SiO₂ without nearly harming the major emission from the wires. However, subsequent thermal annealing treatment was found to be undesirable owing to the degradation of their emission in intensity.

Key Words : Nanostructures, GaS, SiO₂, Core-shell structure, Photoluminescence

Introduction

Gallium sulfide (GaS) is a wide bandgap semiconductor with layered structures of particular interest owing to its highly anisotropic structural, electrical, optical, and mechanical properties. These properties make it a promising candidate for applications in photoelectric devices, electrical sensors, and nonlinear optical applications.¹⁻⁵ Hexagonal GaS, with direct wide band gap of 3.05 eV and indirect band gap of 2.5 eV, is more useful for optoelectronic applications.¹ GaS crystallizes in a layered structure with a double layer of nonmetal atoms, consisting of S-Ga-Ga-S sheets, stacking along the c axis, having intralayer van der Waals bonding and interlayer covalent bonding and is structurally similar to graphite.²⁻⁴ Particularly regarding the optical properties, doped GaS is a promising material for the fabrication of near-blue-light emitting devices.⁵ The GaS thin films deposited on the GaAs substrate are reported to be able to enhance the photoluminescence yield of GaAs by 2 orders of magnitude.⁶

In recent years, one-dimensional (1D) nanostructures have been extensively investigated due to their interesting properties and potential applications in electronics and optoelectronics.^{7,8} There are a few reports on synthesis of GaS nanotubes and thin films fabricated by molecular organic chemical vapor deposition (MOCVD) and molecular beam epitaxy (MBE). However, thermal evaporation may be a more attractive technique in synthesizing GaS nanostructures with an advantage of synthesizing various forms of GaS nanostructures depending on the substrate temperature at lower temperatures compared to other techniques. Recently, Panda *et al.* synthesized short GaS nanobelts using catalyst-assisted thermal evaporation method.⁹ Shen *et al.* reported the controlled synthesis of high quality GaS nanostructures on a large scale using a simple catalyst-free thermal evaporation method.⁸ The morphologies (thin nanowires, nanobelts, zigzag nanobelts, microbelts, hexagonal microplates)

and compositions of the GaS products (heterostructured nanobelts) were controlled by substrate temperature as well as evaporation source.

It is essential to passivate 1D nanostructures with insulating materials to protect them from contamination and oxidation as well as to avoid crosstalk between the building blocks of complex nanoscale circuits.^{11,12} Passivation also offers many advantages such as substantial reduction of surface states, prevention of the surface from adsorption of unwanted species, prevention of unnecessary charge injection, and partial screening of the external fields.^{13,14} In particular, passivation of nanostructures is required in the fabrication of field effect transistors and sensor devices based on nanostructures. Silicon dioxide (SiO₂) is known as one of the most suitable insulating material for nanostructure passivation owing to its excellent insulating property, low dielectric constant, and high mechanical strength as well as compatibility with other materials widely used in integrated circuits (IC) fabrication.¹⁵ SiO₂ is also optically transparent for light absorption or emission of semiconductor nanostructures, resulting in minimal destruction of their intrinsic optical properties such as photoluminescence (PL).^{16,17} On the other hand, various techniques have been reported to be used to form SiO₂ passivation layers on the nanostructure cores. These techniques include sol-gel processes, thermal heating, solution-based methods, CVD, atomic layer deposition (ALD), and sputtering.¹⁸⁻²⁵ Of these techniques, the sol-gel process and solution-based wet processes are prone to contamination. SiO₂ cannot be grown on the GaS nanostructures by thermal heating because no silicon source is contained in the GaS nanostructures. It is difficult to optimize the ALD process condition for SiO₂ coating using a silicon precursor such as SiH₄, Si₂Cl₂, or SiCl₄ and an oxygen precursor such as O₂ or N₂O because of a narrow process window. Therefore, among the above mentioned techniques for the formation of SiO₂ passivation layers, sputtering is the simplest clean technique which can be used for coating SiO₂ onto larva-like

GaS nanostructures. In this paper, we report fabrication of GaS-core/SiO₂-shell larva-like nanostructures by using a two-step process: thermal evaporation of Ga metals and S powders and sputter-deposition of SiO₂. We also investigated the influence of SiO₂ coating on the photoluminescence properties of larva-like GaS nanostructures and thermal annealing on the PL properties of core-shell nanowires and the origin of the change in the PL emission intensity by annealing.

Experimental

GaS nanostructures were synthesized by the thermal evaporation technique based on a vapor-liquid-solid (VLS) mechanism. The thermal evaporation process was carried out in a conventional horizontal tube furnace. Two alumina boats with a length of 4 cm and a diameter of 1.5 cm containing sulfur powders and several pieces of bulk Ga metal were placed in the downstream direction at the center of the quartz tube and a piece of P-type Si (100) wafer used as the substrate for the deposition of GaS nanostructures were placed about 12 cm apart from the alumina boat containing Ga metals in the downstream direction. After the arrangement of the substrates, the tube was pumped down to 0.8 Torr using a rotary pump. High purity argon gas was introduced into the tube with a flow rate of 100 cc/min throughout the whole synthesis process. The temperature of the evaporation sources (Ga metals and S powders) in the furnace was increased to 800 °C at a heating rate of 30 °C/min. The substrate temperature during the evaporation process was measured to be ~700 °C. After maintaining for 1 h, the furnace was cooled to room temperature to take out the products. During the synthesis process, the substrate temperature was monitored using a thermocouple.

Next, coating of the nanostructures with SiO₂ was carried out by sputtering. The sputter-deposition was done at room temperature using a 99.999% SiO₂ target in a radio-frequency (rf) magnetron sputtering system. After the sputtering chamber was evacuated to 1×10^{-6} Torr using a turbomolecular pump backed by a rotary pump. Ar was provided at a flow rate of 20 cc/min. Depositions were carried out at room temperature for 20 min. The system pressure and the rf sputtering power were 1.7×10^{-2} Torr and 100 W, respectively. Subsequently, the prepared SiO₂-coated GaS nanostructure samples were optionally annealed in an O₂ atmosphere at 650 °C for 30 min to see the influence of annealing on the PL properties of the core-shell nanostructures.

The morphology and size of the final products were examined by using scanning electron microscopy (SEM, Hitachi S-4200). High resolution transmission electron microscopy (HRTEM) and selected area electron diffraction (SAED) were carried out on Philips CM-200 electron microscope at an acceleration voltage of 200 kV. The samples used for characterization were dispersed in absolute ethanol and ultrasonicated before TEM observations. Glancing angle (0.5°) X-ray diffraction (XRD) analysis was performed using a Rigaku DMAX 2500 X-ray diffractometer with Cu-

K α radiation with an incident angle of 0.5° to investigate the phases of the obtained products. The compositional analysis was done by using energy dispersive X-ray spectroscopy (EDXS) installed in the TEM. The PL measurement was carried out at room temperature by using a He-Cd laser (Kimon, 1 K, Japan) line (325 nm, 55 mW) as the excitation source.

Results and Discussion

Figure 1(a) shows the SEM image of the as-synthesized SiO₂-coated GaS nanostructures. The nanostructures look like the grains of steamed rice or larvae. Figure 1(a) shows that the widths and lengths of the nanostructures ranged from 100 to 200 nm and from 200 to 700 nm, respectively. A statistical analysis of many SEM images revealed that the diameters of the as-synthesized SiO₂-coated GaS nanostructures ranged from 100 to 400 nm and that the maximum of the diameter distribution was at 150 nm (Fig. 1(b)). The spherical droplets or particles were observed at the tips of many nanostructures (Fig. 1(a), Inset) indicating the VLS growth of the nanostructures. The XRD patterns of the as-

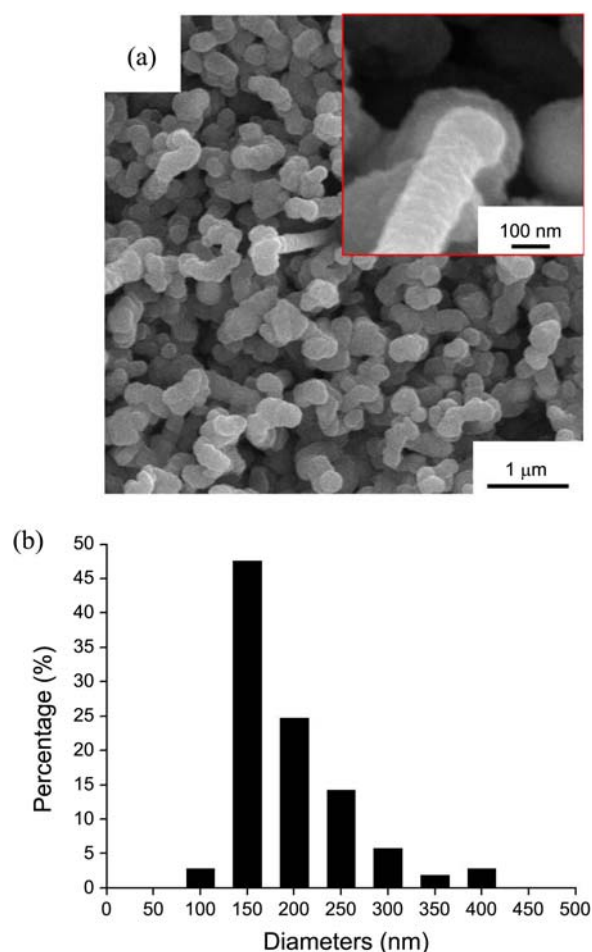


Figure 1. SEM images of the (a) as-synthesized and GaS-core/SiO₂-shell nanostructures. Inset is the enlarged image of a typical nanowire, (b) Distribution of the diameters of the SiO₂-coated ZnO nanostructures.

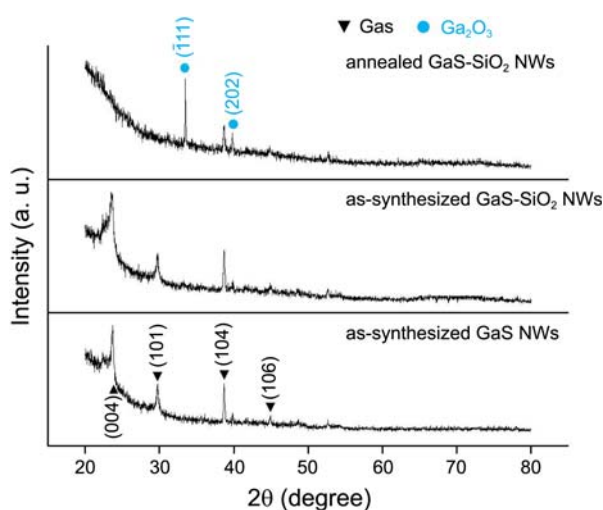


Figure 2. Glancing angle XRD patterns of the SiO₂-coated ZnO nanostructures.

synthesized and annealed SiO₂-coated GaS nanostructures along with that of as-synthesized GaS nanostructures are shown in Figure 2. In both of the SiO₂-coated and uncoated GaS nanostructures four peaks characteristic of wurtzite-type hexagonal GaS (P6₃mc, *a* = 0.3587 nm, *c* = 1.5492 nm) were identified, which were indexed as the (004), (101), (104), (106) reflections from GaS. On the other hand, no reflection peaks of SiO₂ were observable, suggesting that the SiO₂ shells are amorphous. In contrast, Ga₂O₃ (111) and (202) reflections instead of the GaS reflection peaks were observed, indicating that Ga₂O₃ has been transformed to GaS by the annealing process.

Figure 3(a) is the low-magnification TEM image of a

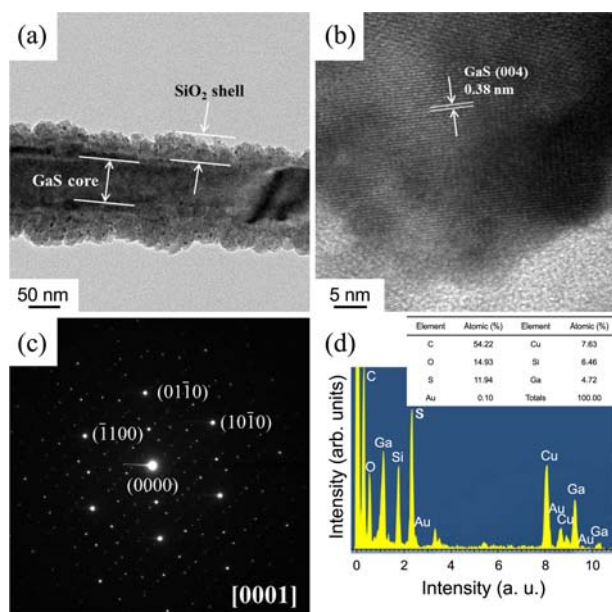


Figure 3. (a) Low-magnification TEM image of a typical SiO₂-coated GaS nanostructure, (b) HRTEM image of a region near the interface of the core and the shell in a typical GaS-core/SiO₂-shell nanostructure, and (c) corresponding SAED pattern, (d) EDX spectrum of GaS-core/SiO₂-shell nanostructures.

typical SiO₂-coated GaS nanostructure clearly showing two segments: a thicker core ~80 nm thick and two thinner coating layers with an average thickness of 30–50 nm on both sides of the core. The high resolution TEM (HRTEM) image of the interfacial area of the core and shell of a typical SiO₂-coated GaS nanostructure and the associated selected area electron diffraction (SAED) pattern taken along the [0001] zone axis are shown in Figures 3(b) and (c). The resolved spacing between the two parallel neighboring fringes is about 0.38 nm, corresponding to the (004) lattice plane of wurtzite GaS. Both the HRTEM image and the SAED pattern indicate that the GaS core is wurtzite-type GaS. In contrast, neither a fringe pattern in the shell layer of the HRTEM image nor the spotty (or ring) pattern for crystalline SiO₂ in the SAED pattern is observed, suggesting that the SiO₂ shell is amorphous. The EDX spectrum for the particle (Fig. 1(d)) shows that the particle comprises Au as well as Ga, S, Si, and O. The Cu detected in the spectrum was not used as a catalyst but as a conductor for TEM sample preparation. These results suggest that the GaS nanostructures were grown through the conventional VLS mechanism in which a liquid Au catalyst droplet was located at the growth front of each wire.²⁶

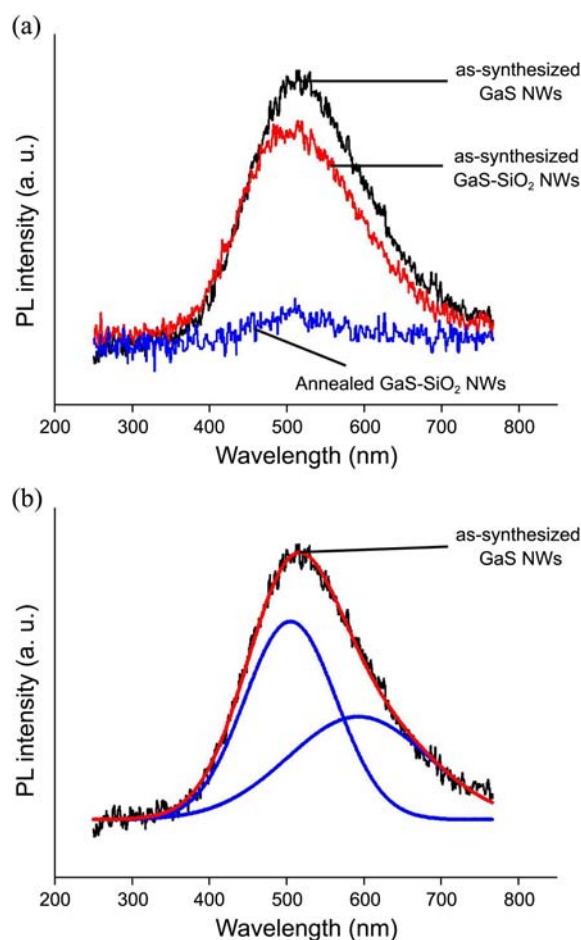


Figure 4. (a) PL spectra of as-synthesized GaS nanostructures, and as-synthesized and annealed GaS-core/SiO₂-shell nanostructures and (b) Gaussian fitting of the PL spectra of the as-synthesized GaS nanostructures.

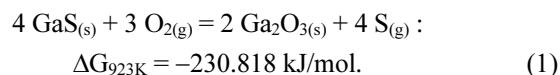
Room-temperature PL measurements were carried out. Figure 4(a) displays the PL spectra of the as-synthesized and annealed GaS nanostructures and as-synthesized and annealed SiO₂-coated GaS nanostructures, *i.e.*, GaS-core/SiO₂-shell nanostructures. The GaS nanostructure sample exhibits a relatively strong green emission at approximately 510 nm. Gaussian fitting (Fig. 4(b)) revealed that the major emission band consisted of the emission band centered at approximately 500 nm and that centered at approximately 610 nm. Aydinli *et al.* reported three broad PL bands centered at 558, 614, and 780 nm at 9 K in the PL spectrum of well aligned GaS horn-like nanostructures.²⁷ The origin of the emission may be attributed mainly to structural defects such as S interstitials, Ga vacancies, stacking defects, and surface states.²⁷ The orange emission peak at 610 nm is in agreement with the emission peak at 614 nm that Aydinli *et al.* reported. On the other hand, the green emission from GaS nanostructures has not been reported before. There are two possibilities regarding the origin of the green emission at 500 nm observed in this study. One possibility is that it is a band-to-band emission considering the band gap energy of GaS. The indirect band gap energy, 2.5 eV of GaS corresponds to 496 nm, which is in good agreement with the green peak in this study (500 nm). The other possibility is that it is also associated with Ga vacancy- or S interstitial-related defects which can easily form recombination centers. The probability of indirect transition occurring in the GaS nanostructures synthesized in this study is low because the nanostructures were not doped with any other impurities. Therefore, it is more reasonable to assume that the green emission also originates from the structural defects. The radiative recombination of electrons from the conduction band minimum by holes from deep acceptor centers such as the aforementioned structural defects might produce PL emissions in the GaS nanostructures.²⁸

In contrast to the GaS nanostructures, the GaS-core/SiO₂-shell nanostructures exhibit a slightly weaker green emission band centered at approximately 510 nm. In other words, the green emission was slightly decreased by coating the GaS nanostructures with SiO₂. This decrease in the PL emission intensity might be attributed to the light absorption by the SiO₂ shell layer. Incident light to the nanostructures and the light emitted by the nanostructures must pass the SiO₂ shell layer. Therefore, the final intensities of the PL emissions must be influenced by the transmittance of the shell layer. It is assumed that the intensity of the light passing through the SiO₂ shell layer is somewhat lower than that of the light before entering the shell layer because the transparency of the thin SiO₂ layer is not perfect. It is important that passivation of the GaS nanostructures could be achieved with SiO₂ without nearly harming the intensity of the major emission from the nanostructures.

On the other hand, the green emission of the GaS-core/SiO₂-shell nanostructures was decreased in intensity considerably by thermal annealing, which might be attributed to the following two sources:

1) Consumption of the GaS phase and formation of a

Ga₂O₃ phase as a result of the following reaction:²⁹



Because the SiO₂ shell layers are as thin as 30-50 nm and the mean diffusion length of O₂ in SiO₂ at 650 °C for 30 min, $x = (Dt)^{1/2} = \sim 1.0 \times 10^5 \text{ nm}$ because the diffusion coefficient of O₂ in SiO₂, $D_{923\text{K}} = \sim 6.0 \times 10^{-8} \text{ cm}^2/\text{sec}$ ³⁰ and $t = 1,800 \text{ sec}$, O₂ molecules can diffuse very easily through the SiO₂ shell layer to reach the GaS-SiO₂ interface and to react with GaS during the annealing process. However, as written above XRD analyses revealed that most of the GaS cores had transformed to Ga₂O₃ during the annealing process. The PL spectrum of the as-synthesized Ga₂O₃ nanowires is commonly characterized by an emission band centered at approximately 510 nm in the green region.^{31,32} This green emission was reported to be associated with the vacancies in the Ga₂O₃ nanostructures, such as gallium (Ga) vacancies, oxygen (O) vacancies³¹ and Ga-O vacancy pairs.³² Therefore, it is not clear if the small emission peak of the GaS-core/SiO₂-shell nanostructures is from the remaining GaS phase or from the newly formed Ga₂O₃ phase. Anyhow, considering the lower intensity of the green emission from the annealed core-shell nanostructures than the as-synthesized core-shell nanostructures we may well assume that the emission intensity of the Ga₂O₃ phase is lower than that of the GaS phase.

2) An increase in the concentration of deep levels such as O interstitials in the GaS cores due to the inflow of O atoms from the O₂ atmosphere into the cores during the annealing process. Even in the case that the O atoms from the O₂ atmosphere did not react with GaS, it would stay as O interstitials which could also be a source for the green emission.

The above experimental results indicate that thermal annealing treatment is not desirable after capping the GaS nanostructures. In addition, the electrical resistivities of the SiO₂-coated and uncoated *i.e.*, as-synthesized GaS nanostructures measured using a four-point probe technique were $1.7 \times 10^{12} \text{ } \Omega \text{ cm}$ and $7.84 \times 10^8 \text{ } \Omega \text{ cm}$, respectively. This result verifies that GaS nanostructures can be passivated by SiO₂ coating in terms of electrical insulation.

Conclusions

Larva-like GaS-core/SiO₂-shell nanostructures were synthesized by a two step process: the thermal evaporation of Ga metal and S powders and the sputter-deposition of SiO₂. The GaS cores and the SiO₂ shells of the nanostructures were single crystal wurtzite-type GaS and amorphous SiO₂, respectively. The as-synthesized GaS nanostructures showed a relatively strong green emission band centered at approximately 510 nm. Passivation of the GaS nanostructures could be achieved with SiO₂ without nearly harming the intensity of the major emission from the nanostructures. Thermal annealing treatment was, however, found to be undesirable owing to the degradation of the emission in intensity.

Acknowledgments. This work was supported by the Korea Research Foundation through ‘the 2010 Core Research Program’.

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